

Supporting Information

Type-I PtS₂/MoS₂ van der Waals Heterojunction with Tunable Photovoltaic Effect and High Photosensitivity

Hui Zhang,^a Zihan Wang,^a Jiawang Chen,^b Chaoyang Tan,^a Shiqi Yin,^a Hanlin Zhang,^a Shaotian Wang,^a Qinggang Qin,^a and Liang Li^{*a,b}

^aInstitutes of Physical Science and Information Technology, Anhui University, Hefei 230601, P. R. China

^bKey Laboratory of Materials Physics, Anhui Key Laboratory of Nanomaterials and Nanotechnology, Institute of Solid State Physics, Hefei Institutes of Physical Science, Chinese Academy of Sciences, Hefei 230031, P.R. China, University of Science and Technology of China, Hefei 230026, P.R. China

*Corresponding author (liliang@issp.ac.cn)

Experimental section:

Device Fabrication

The type-I PtS₂/MoS₂ vdWH device proposed in this work were fabricated by a dry transfer method using PDMS as carrier. First, thick PtS₂ and thin MoS₂ flakes were exfoliated from the bulk counterparts using Scotch tape and then transferred onto a silicon substrate where is covered with 300 nm thick SiO₂. Next, the electrode patterns were defined by electron-beam lithography (EBL, eLINE Plus, Raith), and Ti/Au (15/50 nm) metals were deposited on the silicon substrate by electron beam evaporation and thermal evaporation, respectively. Finally, the plated device was treated by a standard lift-off process in acetone.

Device Characterization and Measurement

The type-I PtS₂/MoS₂ vdWH device was investigated by an optical microscope (WMJ-9688). Raman spectra were measured at room temperature by a Raman/photoluminescence (PL) system (FST2-Ahdx-DZ) equipped with a monochromator and 532 nm laser source. The thickness of the layers and the surface potential were obtained simultaneously by KPFM measurement (Hitachi AFM5500M). The electrical properties of the fabricated devices were measured in a probe station (HFS600E-PB4) using a semiconductor device parameter analyzer (Keithley 4200A-SCS). For photoresponse measurements, the 685 nm laser was keep irradiating on the effective area of the device. All the device measurements were conducted at room temperature in an ambient environment.

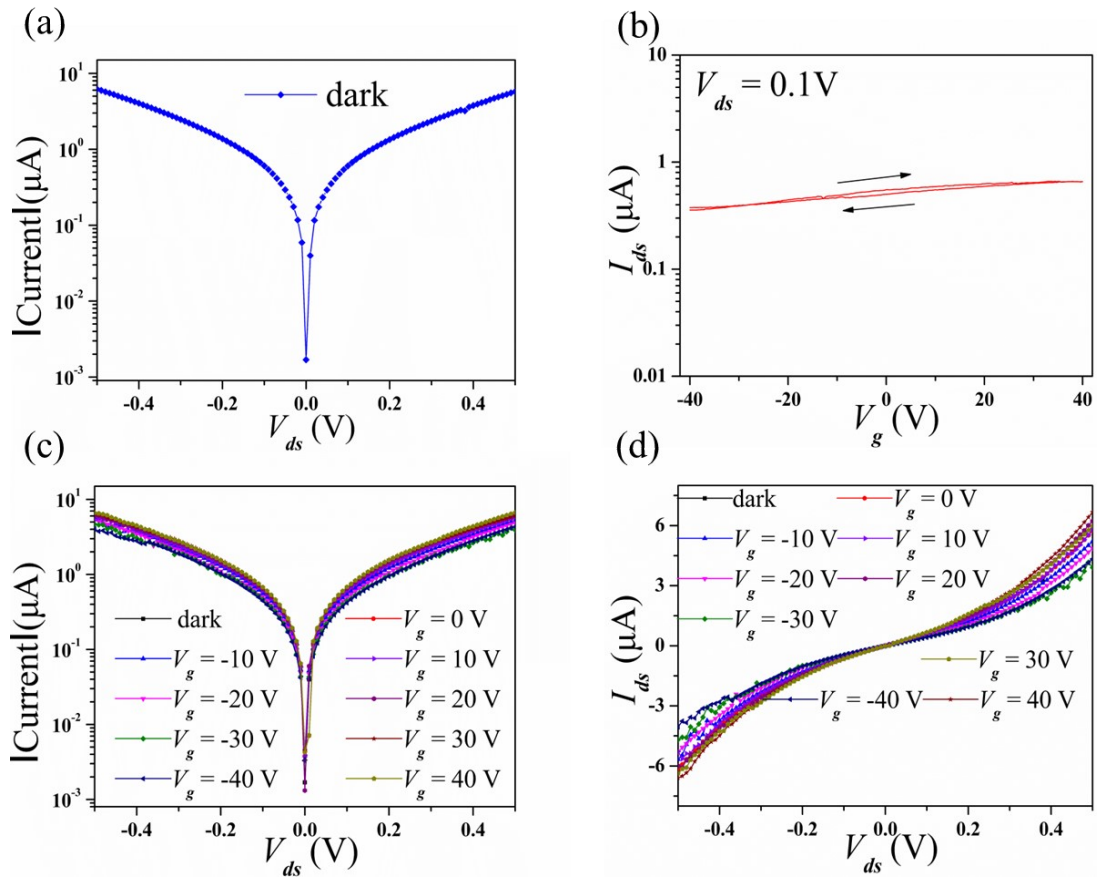


Figure S1. Electrical characterizations of the individual PtS₂ FET. a) I_{ds} - V_{ds} characteristics of the PtS₂ FET in the dark. b) Transfer curve of the PtS₂ FET at $V_{ds} = 0.1$ V. I_{ds} - V_{ds} curves of the PtS₂ FET under different gate voltages in c) logarithmic scale and d) liner scale.

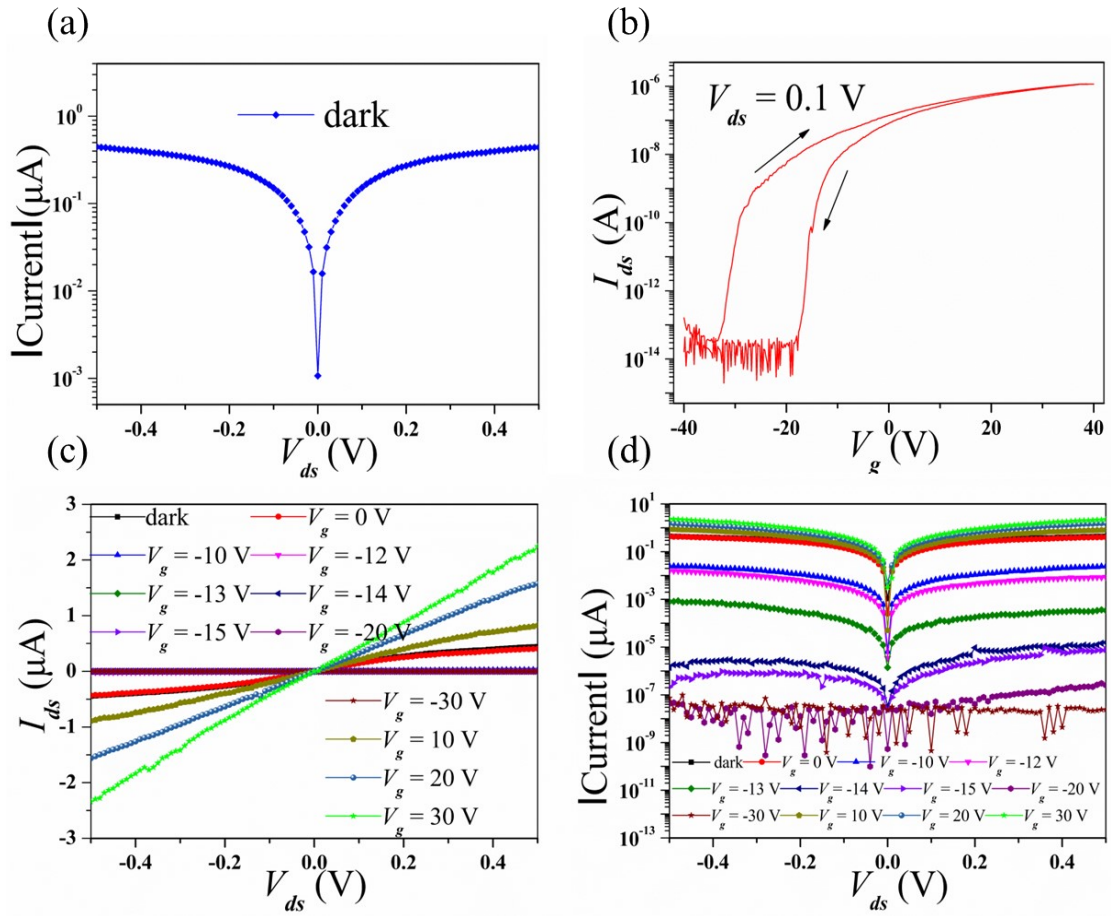


Figure S2. Electrical characterizations of the individual MoS₂ FET. a) I_{ds} - V_{ds} characteristics of the MoS₂ FET in the dark. b) Transfer curve of the MoS₂ FET at $V_{ds} = 0.1 \text{ V}$. I_{ds} - V_{ds} curves of the MoS₂ FET under different gate voltages in c) linear scale and d) logarithmic scale.

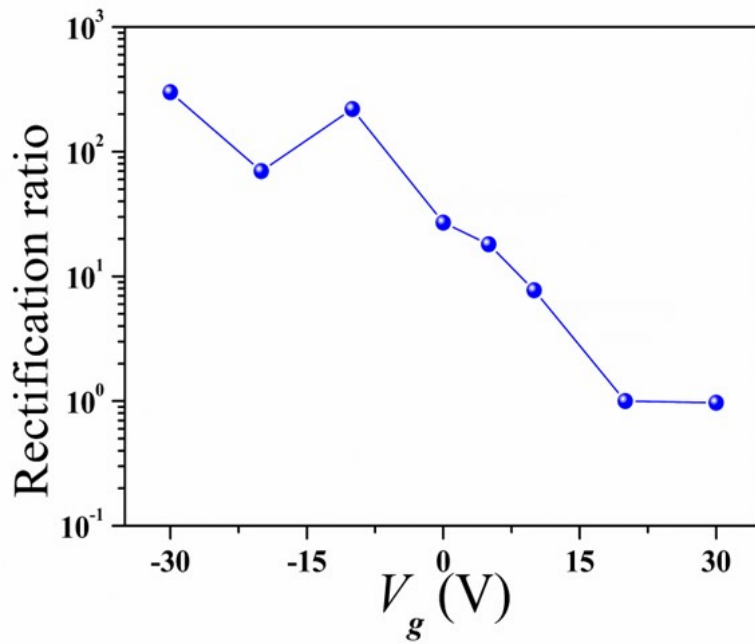


Figure S3. The forward rectification ratio of PtS₂/MoS₂ heterojunction at various gate voltages.

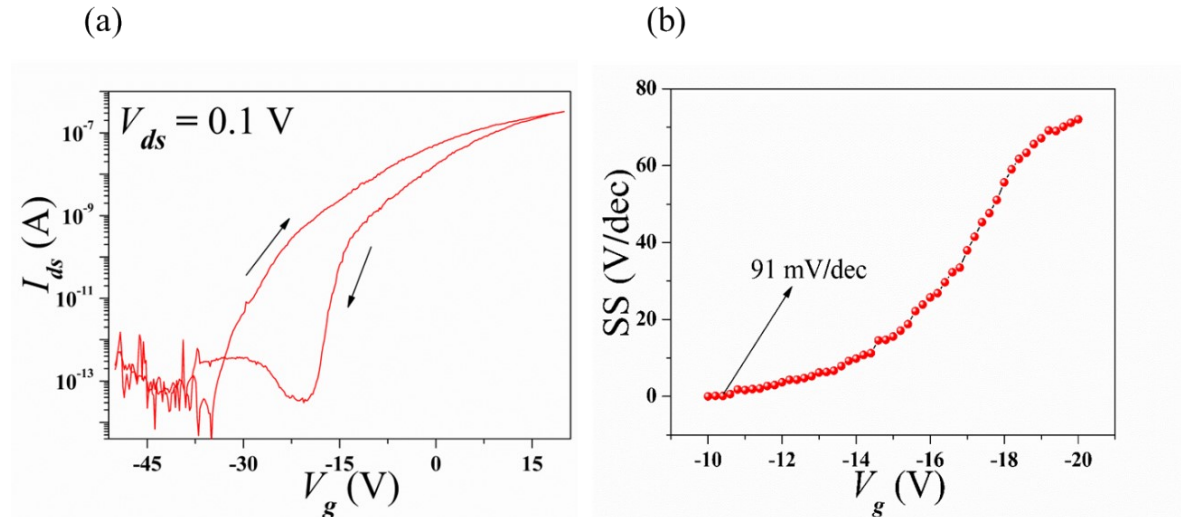


Figure S4. a) I_{ds} - V_g transfer curve of the PtS₂/MoS₂ vdWH device in the main text. b) Subthreshold swing (SS) of the PtS₂/MoS₂ vdWH device in the main text as a function of V_g .

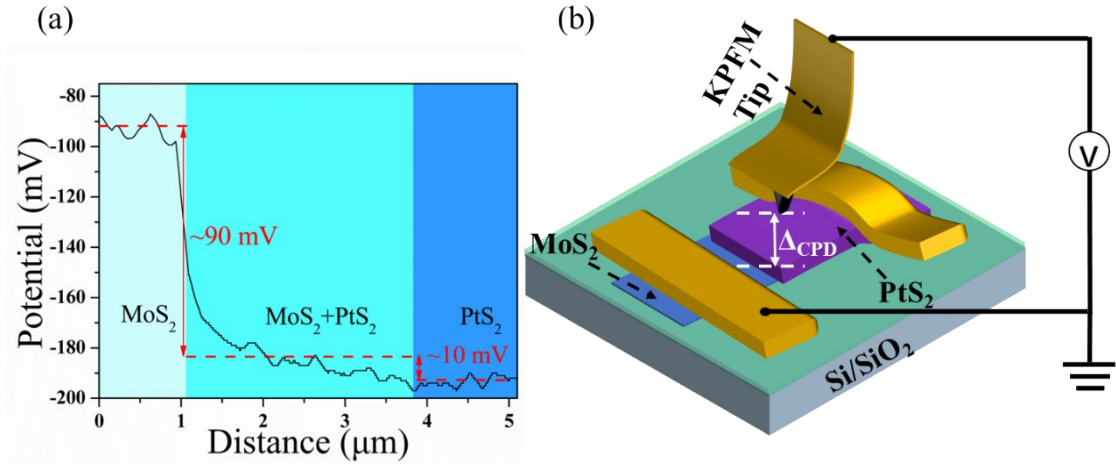


Figure S5. a) The surface potential profile in the region of MoS₂, MoS₂/PtS₂, and PtS₂. b) The schematic diagram of the measurement of KPFM, the value of Δ_{CPD} is the surface potential of tip mental of Rh ($\Phi_{\text{Tip}} = 4.9 \text{ eV}$) minus the surface potential of the heterojunction ($\Delta_{\text{CPD}} = \Phi_{\text{Tip}} - \Phi_{\text{Sample}}$).

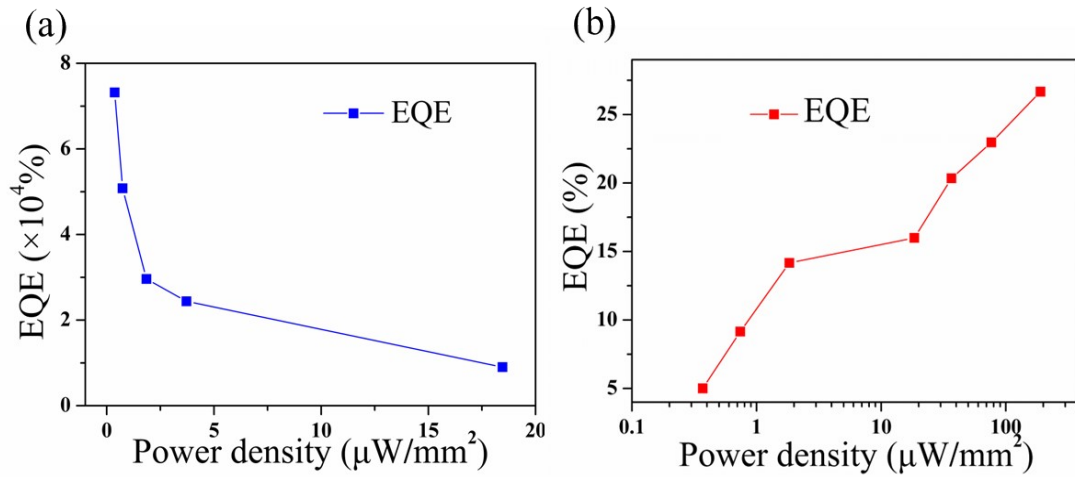


Figure S6. The calculated EQE values illuminated by 685 nm light at a) $V_g = 0 \text{ V}$, $V_{\text{ds}} = 0.1 \text{ V}$ and b) $V_g = -40 \text{ V}$, $V_{\text{ds}} = 0.1 \text{ V}$.

Table S1. Comprehensive comparison of the critical parameters of fabricated PtS₂/MoS₂ vdWHs with previously reported MoS₂ based photodetectors

Materials	Wavelength (nm)	Condition	R (A W ⁻¹)	D* (Jones)	EQE (%)	Response time	Ref.
PtS ₂ /MoS ₂	685	V _g = 0, V _{ds} = 0.1 V	403	1.07×10 ¹¹	7.32×10 ⁴	24/21 ms	This Work
MoS ₂	532	V _g = 0, V _{ds} = 1 V	15.6			100ms	1
ZnO-QDs/MoS ₂	635	V _g = 0, V _{ds} = 1 V	0.084	1.05×10 ¹¹	25.7	1.5/1.1s	2
Si/MoS ₂	532	V _g = 0, V _{ds} = 3 V	117	1×10 ⁹	55	74/115ms	3
GaSe/MoS ₂	450	V _g = 0, V _{ds} = 0	0.9	6.5×10 ⁹		5/5 ms	4
Graphene/MoS ₂	540	V _g = 0, V _{ds} = 5 V	0.835			20/30 ms	5
PdSe ₂ /MoS ₂	532	V _g = 0, V _{ds} = 0	9	3×10 ¹⁰		125/7 ms	6
MoTe ₂ /MoS ₂	470	V _g = 0, V _{ds} = 0	0.322		85	25 ms	7

References

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